MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

PDIP6 8.51x6.35, 2.54P
CASE 646BX
ISSUE O

DATE 31 JUL 2016

NOTES:
A) NO STANDARD APPLIES TO THIS PACKAGE.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONS ARE EXCLUSIVE OF BURRRS, MOLD FLASH, AND TIE BAR EXTRUSION

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